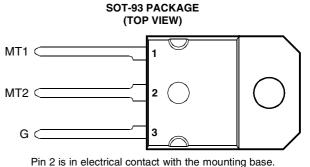
BOURNS®

- High Current Triacs
- 20 A RMS
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- 150 A Peak Current
- Max I_{GT} of 50 mA (Quadrants 1 3)



MDC2ADA

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT	
TIC253D		400		
Depetitive peak off state veltage (see Nate 1)		600	v	
Repetitive peak off-state voltage (see Note 1) TIC253S	VDRM	700		
TIC253N		800		
Full-cycle RMS on-state current at (or below) 70°C case temperature (see Note 2)	I _{T(RMS)}	20	A	
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)	I _{TSM}	150	A	
Peak gate current	I _{GM}	±1	A	
Operating case temperature range	т _с	-40 to +110	°C	
Storage temperature range	T _{stg}	-40 to +125	°C	
Lead temperature 1.6 mm from case for 10 seconds	TL	230	°C	

NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.

2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 500 mA/°C.

3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of peak reverse volta ge and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	ТҮР	MAX	UNIT
I _{DRM}	Repetitive peak off-state current	$V_D = Rated V_{DRM}$	$I_{G} = 0$	$T_{C} = 110^{\circ}C$			±2	mA
I _{GT}		V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		15	50	mA
	Gate trigger	$V_{supply} = +12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-30	-50	
	current	$V_{supply} = -12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-20	-50	
		V _{supply} = -12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		32		
V _{GT}		V _{supply} = +12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		0.8	2	v
	Gate trigger	$V_{supply} = +12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-0.8	-2	
	voltage	V _{supply} = -12 V†	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		-0.8	-2	
		$V_{supply} = -12 V^{\dagger}$	$R_L = 10 \Omega$	t _{p(g)} > 20 μs		0.8	2	
V _T	On-state voltage	I _T = ±28.2 A	l _G = 50 mA	(see Note 4)		±1.4	±1.7	V

† All voltages are with respect to Main Terminal 1.

NOTE 4: This parameter must be measured using pulse techniques, $t_p = \le 1$ ms, duty cycle ≤ 2 %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

PRODUCT INFORMATION

DECEMBER 1971 - REVISED SEPTEMBER 2002 Specifications are subject to change without notice.

electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER TEST CONDIT			ONS	MIN	ТҮР	MAX	UNIT	
I	Holding current	V _{supply} = +12 V†	l _G = 0	Init' I _T = 100 mA		20	40	mA
Ч		V _{supply} = -12 V†	$I_{G} = 0$	Init' I _T = -100 mA		-10	-40	ША
IL.	Latching current	V _{supply} = +12 V†	(see Note 5)			20		mA
		V _{supply} = -12 V†	(See Note 5)		-20			
dv/dt	Critical rate of rise of	V _D = Rated V _D	I _G = 0	T _C = 110°C		±450		V/µs
uv/ut	off-state voltage			1 _C = 110 0				
dy/dt	Critical rise of	V _D = Rated V _D		$T_{C} = 80^{\circ}C$		±1		V/µs
dv/dt _(c)	commutation voltage	$di/dt = 0.5 I_{T(RMS)}/ms$		$I_T = 1.4 I_{T(RMS)}$				v/µs
di/dt	Critical rate of rise of	V _D = Rated V _D	I _{GT} = 50 mA	$I_{GT} = 50 \text{ mA}$ $T_{C} = 110^{\circ}\text{C}$		±100		A/µs
	on -state current	di _G /dt = 50 mA/µs		C = 1100				-7,μ5

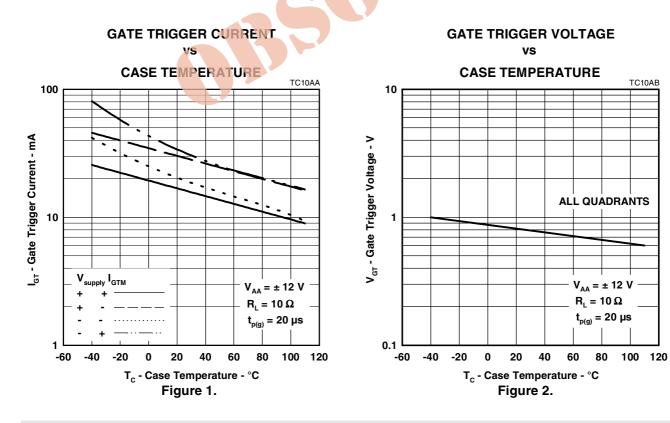
† All voltages are with respect to Main Terminal 1.

NOTE 5: The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics: $R_G = 100 \ \Omega$, $t_{p(g)} = 20 \ \mu s$, $t_r = \le 15 \ ns$, $f = 1 \ kHz$.

thermal characteristics

PARAMETER			TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.52	°C/W
R_{\thetaJA}	Junction to free air thermal resistance			36	°C/W

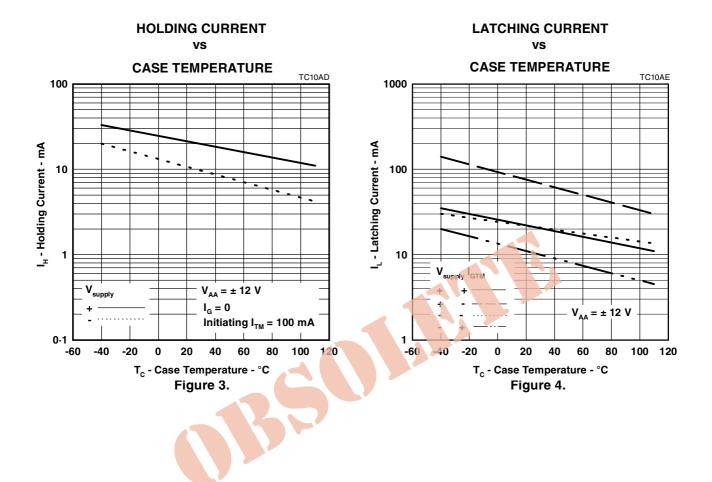




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TYPICAL CHARACTERISTICS



PRODUCT INFORMATION